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**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

IN RE APPLICATION OF: LINLIN CHEN *ET AL.*

FILED: OCTOBER 27, 2003

FOR: **APPARATUS AND METHOD FOR  
ELECTROLYTICALLY DEPOSITING  
COPPER ON A SEMICONDUCTOR  
WORKPIECE**

**Preliminary Amendment**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Commissioner:

Prior to examination on the merits, please amend the above-identified application as follows:

Amendments to the Specification begin on page 2.